

# **Tputty™ 502 Series**

Innovative **Technology** for a **Connected** World



### **CREATES COMPRESSION OF INTERFACE MATERIAL**

Tputty<sup>™</sup> 502 is the best material for applications where large tolerance differences create the need for compression of the interface material beyond 50% of its original thickness.

Tputty<sup>™</sup> 502 will flow and ensure low pressures on the components being cooled. In conjunction with outstanding compression characteristics, Tputty<sup>™</sup> 502 has a high thermal conductivity, resulting in very low thermal resistance.

Tputty<sup>™</sup> 502 is naturally tacky and requires no additional adhesive coating that can inhibit thermal performance.

### **FEATURES AND BENEFITS**

- Soft and ultra high compressibility for low stress applications
- 3 W/mK thermal conductivity
- Available in sheets 0.020" 0.200"
  (0.5mm (5.0mm) thick and in bulk
- Naturally tacky needing no further adhesive coating

#### **APPLICATIONS**

- Cooling components to the chassis or frame
- Entire large panel PCB cooling
- Semiconductor automated test equipment (ATE)
- Any high compression low stress application

### global solutions: local support ™

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# **Tputty™ 502 Series**

## Innovative **Technology** for a **Connected** World

|                                       | Tputty™ 0.020                                      | Tputty™ 0.040                                      | Tputty™ 0.060                                      | Tputty™ 0.080                                      | Tputty™ 0.100                                      | TEST METHOD              |
|---------------------------------------|--|--|--|--|--|--------------------------|
| Construction & Composition            | Reinforced boron nitride filled silicone elastomer |                          |
| Color                                 | White  | White  | White  | White  | White  | Visual                   |
| Thickness                             | 0.020" (0.51mm)                                    | 0.040" (1.02mm)                                    | 0.060" (1.52mm)                                    | 0.080" (2.03mm)                                    | 0.100" (2.54mm)                                    |                          |
| Thickness Tolerance                   | ± 0.002" (± 0.05mm)                                | ± 0.003" (± 0.08mm)                                | ± 0.004" (± 0.10mm)                                | ± 0.004" (± 0.10mm)                                | ± 0.005" (± 0.13mm)                                |                          |
| Specific Gravity                      | 1.39 g/cc  | 1.38 g/cc  | 1.37 g/cc  | 1.37 g/cc  | 1.36 g/cc  | Helium<br>Pycnometer     |
| Hardness *without fiberglass          | 05 Shore OO  | ASTM D2240               |
| Outgassing TML<br>(Post Cured)        | 0.11%  | 0.11%  | 0.11%  | 0.11%  | 0.11%  | ASTM E595                |
| Outgassing CVCM<br>(Post Cured)       | 0.06%  | 0.06%  | 0.06%  | 0.06%  | 0.06%  | ASTM E595                |
| Temperature Range                     | -45°C to 200°C                                     |                          |
| Thermal<br>Conductivity               | 3 W/mK   | ASTM D5470<br>(modified) |
| Thermal Impedance<br>@ 10 psi @ 69KPa | 0.44 °C-in²/W 2.84<br>°C-cm²/W                     | 0.49 °C-in²/W 3.16<br>°C-cm²/W                     | 0.53 °C-in²/W 3.42<br>°C-cm²/W                     | 0.58 °C-in²/W 3.74<br>°C-cm²/W                     | 0.62 °C-in²/W 4.00<br>°C-cm²/W                     | ASTM D5470<br>(modified) |
| Thermal Expansion                     | 92 ppm/C   | IPC-TM-650<br>2.4.24     |
| Breakdown Voltage                     | 2000 Volts AC                                      | 4000 Volts AC                                      | >5000 Volts AC                                     | >5000 Volts AC                                     | >5000 Volts AC                                     | ASTM D149                |
| Volume Resistivity                    | 5 x 10 <sup>13</sup> ohm-cm                        | ASTM D257                |
| Dielectric Constant<br>@ 1MHz         | 3.20   | 3.20   | 3.20   | 3.20   | 3.20   | ASTM D150                |

### STANDARD THICKNESSES

| 0.020" (0.51mm) | 0.030" (0.76mm) | 0.040" (1.02mm) | 0.050" (1.27mm) |
|-----------------|-----------------|-----------------|-----------------|
| 0.060" (1.52mm) | 0.070" (1.78mm) | 0.080" (2.03mm) | 0.090" (2.29mm) |
| 0.100" (2.54mm) | 0.110" (2.79mm) | 0.120" (3.05mm) | 0.130" (3.30mm) |
| 0.140" (3.56mm) | 0.150" (3.81mm) | 0.160" (4.06mm) | 0.170" (4.32mm) |
| 0.180" (4.57mm) | 0.190" (4.83mm) | 0.200" (5.08mm) |                 |

Consult the factory for alternate thicknesses.

### **BULK**

Tputty  $^{TM}$  502 is available in bulk form in the following sizes: 100 cc Jar 500 cc Jar 1000 cc Jar

Consult the factory for alternate bulk sizes.

### **STANDARD SHEET SIZES**

9" x 9" (229mm x 229mm) and 18" x 18" (457mm x 457mm).

9" x 9" only over 0.100" thickness

Tputty<sup>TM</sup> 502 is available in individual die cut shapes. Pressure sensitive adhesive is not applicable for Tputty<sup>TM</sup> products.

### REINFORCEMENT

Tputty  $^{\text{TM}}$  502 sheets are reinforced on both sides with fiberglass.

Data for design engineer guidance only. Observed performance varies in application. Engineers are reminded to test the material in application.

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